SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

Electrical Specifications T_A = +25°C, Unless Otherwise Specified

PARAMETER	TEST CONDITIONS	MIN	TYPICAL	MAX	UNITS
Reverse Standoff Voltage	I = 10µA	5.5	-	-	V
Reverse Standoff Leakage Current	V = 5.0V		1	100	nA
Signal Clamp Voltage					
Positive	I = 10mA	5.6	6.8	8	V
Negative	I = 10mA	-1.2	-0.8	-0.4	V
Clamp Voltage during ESD					
MIL-STD-883 Method 3015 (HBM) test					
8kV			12		V
8kV			-8		V
ESD Test Level (1)					
IEC-61000-2, Contact discharge		20			kV
MIL-STD-883 Method 3015 (HBM)		30			kV
Capacitance	2.5V @ 1Mhz		30		pF
Turn on/off Time			<1		ns
Temperature Range					
Operating		-40		85	°C
Storage		-65		150	°C
Diode Dynamic Resistance					
Forward Conduction			1.0		Ω
Reverse Conduction			1.4		Ω

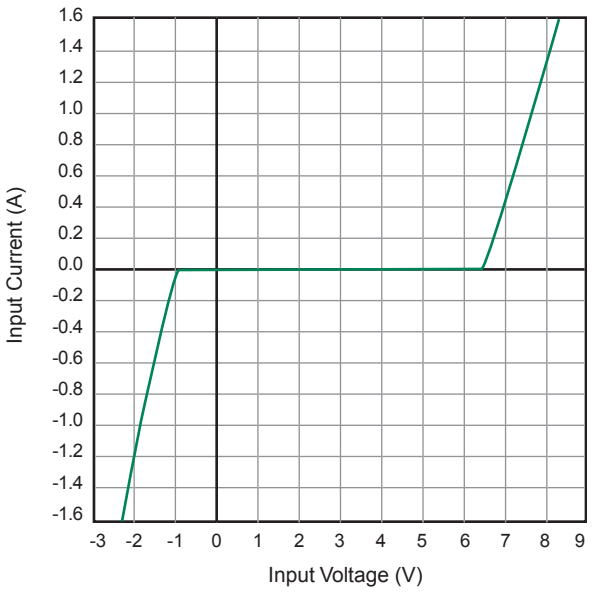
Note:
(1) ESD voltage applied between channel pins and ground, one pin at a time; all other channel pins are open; all ground pins are grounded.

Absolute Maximum Ratings		
Parameter	**Rating**	**Unit**
Storage Temperature Range	-65 to + 150	C
Package Power Dissipation SC70 SOT23-3, SOT23-5, SOT23-6, SOT143 TSSOP, MSOP	 0.2 0.225 0.5	 W W W

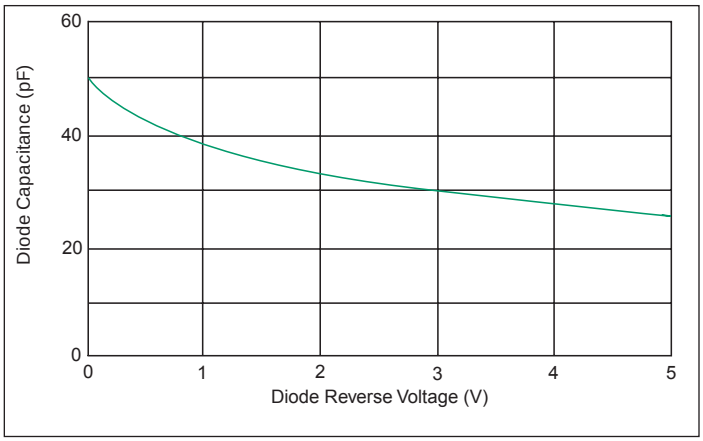
SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

Typical Input VI Characteristics

(Pulse-mode measurements, pulse width = 0.7 mS nominal)



Typical Diode Capacitance vs. Reverse Voltage



Package Information

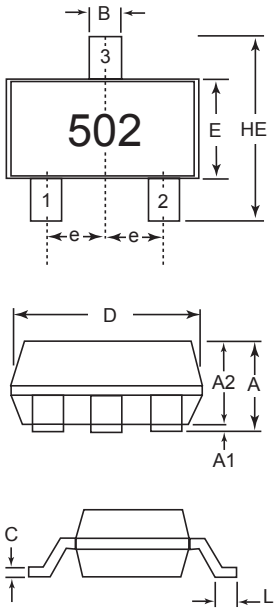
Mechanical Specifications	
Lead Plating	Tin-Lead
Lead Material	Copper Alloy
Lead Coplanarity	0.004 inches (0.102mm)
Subsitute Material	Silicon
Body Material	Molded Epoxy
Flammability	UL94-V-0

Notes:
1. All dimensions are in millimeters.
2. Dimensions include solder plating.
3. Dimensions are exclusive of mold flash & metal burr.
4. All specifications comply to JEDEC SPEC MO-203 ISSUE A.
5. Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
6. Package surface matte finish VDI 11-13.

SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

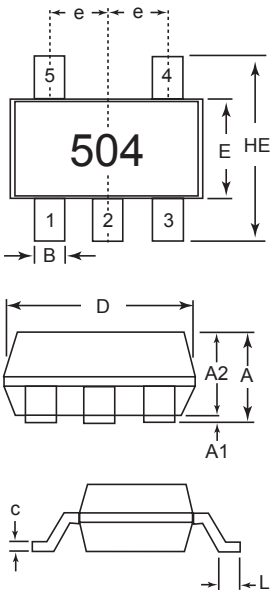
Outline Drawings

SP0502BAJT - SC70-3



Package	SC70-3			
Pins	3			
JEDEC	MO-203 Issue A			
	mm		inches	
	min	max	min	max
A	0.80	1.10	0.031	0.043
A1	0.00	0.10	0.00	0.004
A2	0.70	1.00	0.028	0.039
B	0.15	0.30	0.006	0.012
c	0.08	0.25	0.003	0.010
D	1.85	2.25	0.073	0.089
E	1.15	1.35	0.045	0.053
e	0.66 BSC		0.026 BSC	
HE	2.00	2.40	0.079	0.094
L	0.26	0.46	0.010	0.018

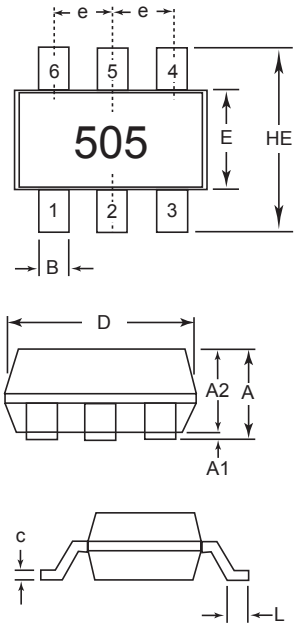
SP0504BAJT - SC70-5



Package	SC70-5			
Pins	5			
JEDEC	MO-203 Issue A			
	mm		inches	
	min	max	min	max
A	0.80	1.10	0.03	0.043
A1	0.00	0.10	0.00	0.004
A2	0.70	1.00	0.028	0.039
B	0.15	0.30	0.006	0.012
c	0.08	0.25	0.003	0.010
D	1.85	2.25	0.073	0.089
E	1.15	1.35	0.045	0.053
e	0.65 BSC		0.026 BSC	
HE	2.00	2.40	0.079	0.094
L	0.26	0.46	0.010	0.018

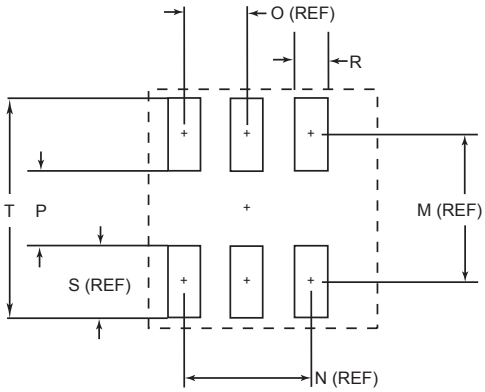
SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

Outline Drawings

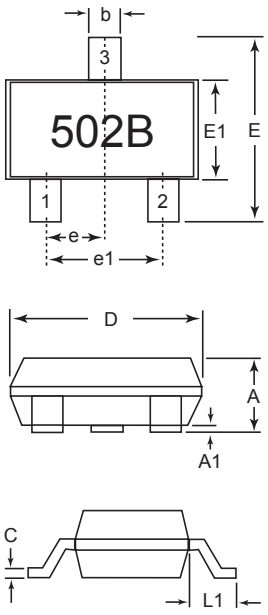


SP0505BAJT - SC70-6

Recommended Pad Layout

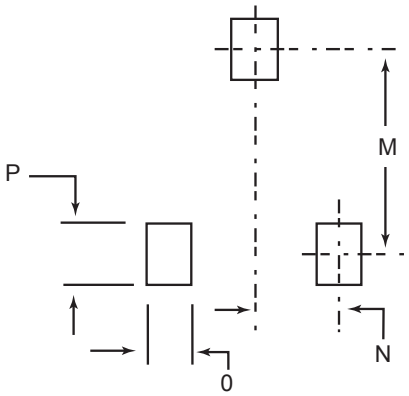


Package	SC70-6			
Pins	5			
JEDEC	MO-203 Issue A			
	mm		inches	
	min	max	min	max
A	0.80	1.10	0.031	0.043
A1	0.00	0.10	0.00	0.004
A2	0.70	1.00	0.028	0.039
B	0.15	0.30	0.006	0.012
c	0.08	0.25	0.003	0.010
D	1.85	2.25	0.073	0.089
E	1.15	1.35	0.045	0.053
e	0.65 BSC		0.026 BSC	
HE	2.00	2.40	0.079	0.094
L	0.26	0.46	0.010	0.018
M	-	1.60	-	0.063
N	-	1.30	-	0.052
O	-	0.65	-	0.026
P	-	0.70	-	0.058
R	-	0.35	-	0.014
S	-	0.90	-	0.035
T	-	2.50	-	0.098



SP0502BAHT - SOT23

Recommended Pad Layout

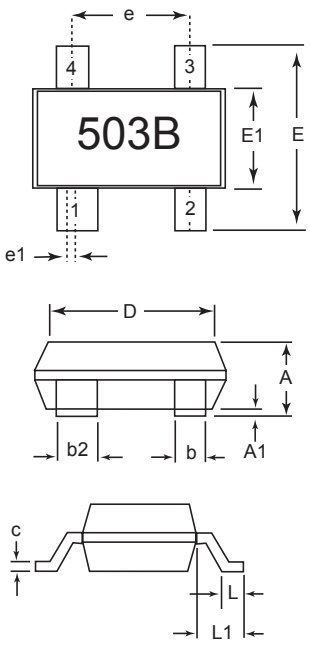


Package	SOT23			
Pins	3			
JEDEC	TO-236			
	mm		inches	
	min	max	min	max
A	0.89	1.12	0.035	0.044
A1	0.01	0.1	0.0004	0.004
b	0.3	0.5	0.012	0.020
c	0.08	0.2	0.003	0.008
D	2.8	3.04	0.110	0.120
E	2.1	2.64	0.083	0.104
E1	1.2	1.4	0.047	0.055
e	0.95 BSC		0.95 BSC	
e1	1.90 BSC		1.90 BSC	
L1	0.54 REF		0.54 REF	
M		2.29		.090
N		0.95		.0375
O		0.78		.030TYP
P		0.78		.030TYP

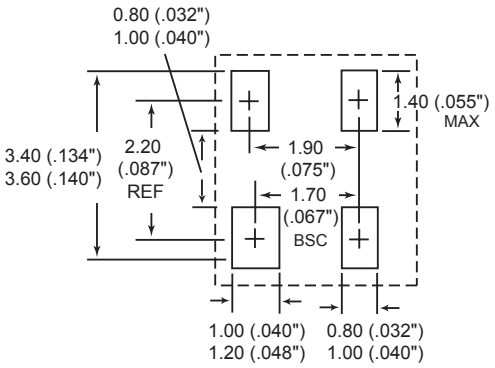
SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

Outline Drawings

SP0503BAHT - SOT143

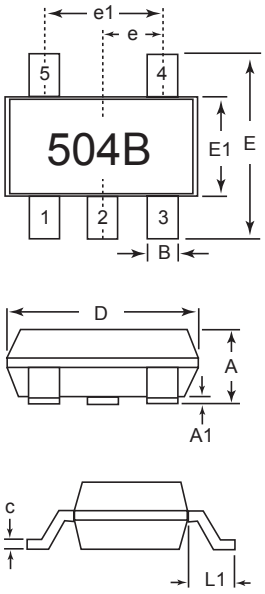


Recommended Pad Layout

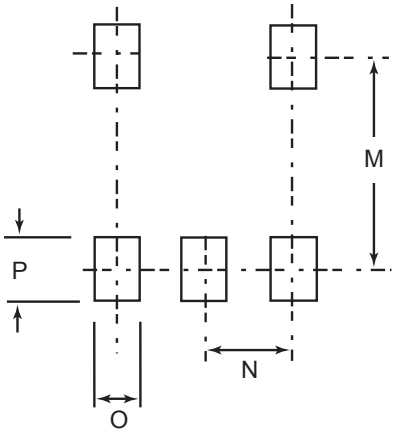


Package	SOT143			
Pins	4			
JEDEC	TO-253			
	mm		inches	
	min	max	min	max
A	0.08	1.22	0.031	0.048
A1	0.05	0.15	0.002	0.006
b	0.30	0.50	0.012	0.019
b2	0.76	0.89	0.030	0.035
c	0.08	0.20	0.003	0.008
D	2.80	3.04	0.110	0.119
E	2.10	2.64	0.082	0.103
E1	1.20	1.40	0.047	0.055
e	1.92 BSC		0.076 BSC	
e1	0.20 BSC		0.008 BSC	
L	0.4	0.6	0.016	0.024
L1	0.550 REF		0.022 REF	

SP0504BAHT - SOT23-5



Recommended Pad Layout

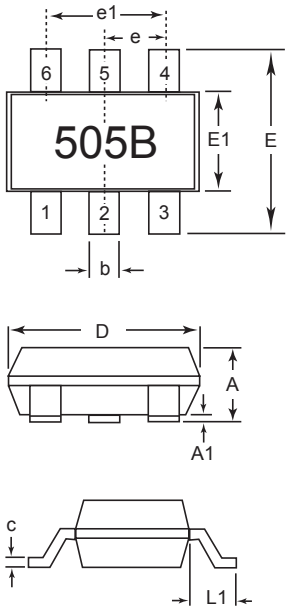


Package	SOT23-5			
Pins	5			
JEDEC	MO-178			
	mm		inches	
	min	max	min	max
A	-	1.45	-	0.057
A1	0	0.15	0	0.006
b	0.3	0.5	0.012	0.020
c	0.08	0.22	0.003	0.009
D	2.75	3.05	0.108	0.120
E	2.6	3.0	0.102	0.118
E1	1.45	1.75	0.057	0.069
e	0.95 BSC		0.95 BSC	
e1	1.90 BSC		1.90 BSC	
L1	0.60 REF		0.60 REF	
M		2.59		.102
N		0.95		.038
O		0.69		.027TYP
P		0.99		.039TYP

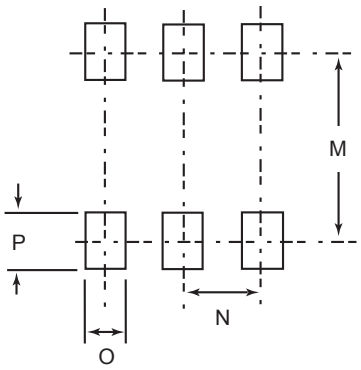
SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

Outline Drawings

SP0505BAHT - SOT23-6

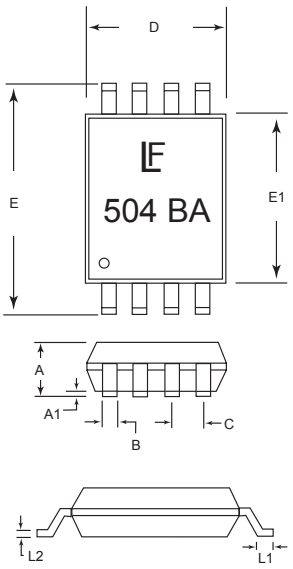


Recommended Pad Layout



Package	SOT23-6			
Pins	6			
JEDEC	MO-178			
	mm		inches	
	min	max	min	max
A	-	1.45	-	0.057
A1	0	0.15	0	0.006
b	0.3	0.5	0.012	0.020
c	0.08	0.22	0.003	0.009
D	2.75	3.05	0.108	0.120
E	2.6	3.0	0.102	0.118
E1	1.45	1.75	0.057	0.069
e	0.95 BSC		0.95 BSC	
e1	1.90 BSC		1.90 BSC	
L1	0.60 REF		0.60 REF	
M		2.59		.102
N		0.95		0.038
O		0.69		.027TYP
P		0.99		.039TYP
P_D@70°C	.225W			

SP0504BAAT - TSSOP-8

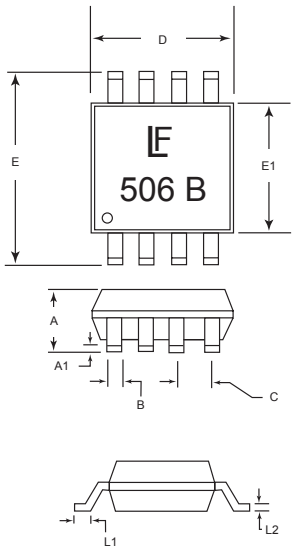


Package	TSSOP-8			
	mm		inches	
	min	max	min	max
D	2.90	3.10	.144	.122
E	6.40 REF		.252 REF	
E1	4.29	4.50	.17	.18
A	1.194 REF		.047 REF	
A1	0.051	0.152	.002	0.006
B	-	0.30	-	.12TYP
C	-	0.66	-	.26TYP
L1	0.51	0.76	.020	.030
L2	0.102	0.203	.004	.008

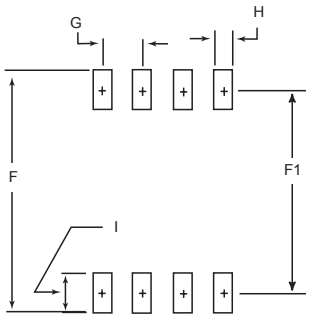
SP0502BA, SP0503BA, SP0504BA, SP0505BA, SP0506BA

Outline Drawings

SP0506BAAT - MSOP-8



Recommended Pad Layout



Package	MSOP-8			
	mm		inches	
	min	max	min	max
D	2.90	3.10	.144	.122
E	4.78	4.98	.188	.196
E1	2.90	3.10	.114	.122
A	0.87	1.17	.034	.046
A1	0.05	0.25	.002	0.10
B	-	0.30TYP	-	.12TYP
C	-	0.65TYP	-	.25TYP
L1	0.52	0.54	.017	.025
L2	-	0.18TYP	-	.007TYP
F	-	5.28	-	.208
F1	-	4.24	-	.167
G	-	0.65	-	.0256
H	-	0.38	-	.015
I	-	1.04	-	.041